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**OKUZAWA et al.**(10) **Pub. No.: US 2023/0230757 A1**(43) **Pub. Date: Jul. 20, 2023**(54) **LAMINATED COIL COMPONENT****Publication Classification**(71) Applicant: **TDK CORPORATION**, Tokyo (JP)(51) **Int. Cl.**  
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(2013.01); **H01F 27/2809** (2013.01)(73) Assignee: **TDK CORPORATION**, Tokyo (JP)(57) **ABSTRACT**(21) Appl. No.: **18/153,690**(22) Filed: **Jan. 12, 2023**(30) **Foreign Application Priority Data**

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A laminated coil component includes an element body, a first terminal electrode and a second terminal electrode, and a coil, the coil includes a first wiring portion, a second wiring portion, and a pillar portion, the pillar portion has a first pillar member and a second pillar member alternately laminated in a second direction, and an area of a first surface and an area of a second surface of the first pillar member are larger than an area of a first surface and an area of a second surface of the second pillar member, or smaller than the area of the first surface and the area of the second surface of the second pillar member.

